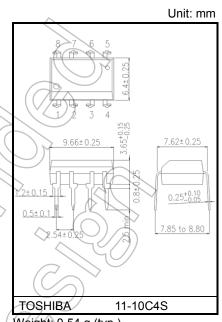
TOSHIBA Photocoupler IRED & Photo IC

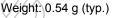
# TLP2530, TLP2531

Digital Logic Isolation Line Receiver Power Supply Control Switching Power Supply Industrial Inverter

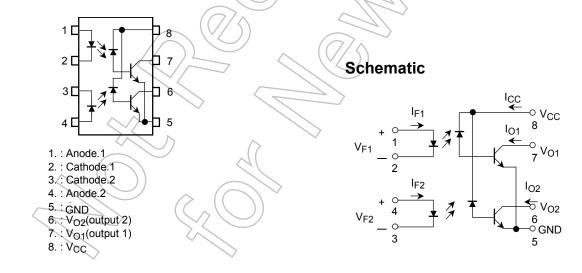
The TOSHIBA TLP2530 and TLP2531 dual photocouplers consist of a pair of infrared emitting diode and integrated photodetector. This unit is 8-lead DIP. Separate connection for the photodiode bias and output transistor collectors improve the speed up to a hundred times that of a conventional phototransistor coupler by reducing the base-collector capacitance.

- TTL compatible
- Switching speed: tpHL = 0.2  $\mu$ s, tpLH = 0.3  $\mu$ s (typ.) (@RL = 1.9 k $\Omega$ )
- Guaranteed performance over temp: 0°C to 70°C
- Isolation voltage: 2500 Vrms (min)
- UL-recognized: UL1577, File No.E67349
- cUL-recognized: CSA Component Acceptance Service No.5A File No.E67349





### Pin Configuration (top view)



### Absolute Maximum Ratings (Ta = 25°C)

	Characteristic	Symbol	Rating	Unit
	Forward current (each channel)	lF	25	mA
	Forward current derating (each channel) (Ta> 70 °C)	∆IF/Ta	-0.8	mA / °C
LED	Pulse forward current (each channel) (Note 1)	IFP	50	mA
	Pulse forward current derating (each channel) (Ta> 70 °C)	∆IFP/Ta	-1.6	mA / °C
	Total pulse forward current (each channel) (Note 2)	IFPT		А
	Reverse voltage (each channel)	VR	5	V
	Diode power dissipation (each channel)	PD	45	mW
	Diode power dissipation derating (each channel) (Ta> 70 °C)	ΔPD/Ta	-0.8	mW / °C
	Output current(each channel)	40	8	mA
	Peak output current (each channel)	IOP	16	mA
tor	Output voltage(each channel)	Vo	-0.5 to 15	X
Detector	Supply voltage	Vcc	-0.5 to 15	Ň
	Output power dissipation (each channel)	Po	35	m₩
	Output power dissipation derating (each channel) (Ta> 70 °C)	∆Po/Ta	-0.6	mW / °C
Ope	erating temperature range	Topr	-55 to 100	°C
Stor	rage temperature range	Tstg	-55 to 125	°C
Lea	d solder temperature(10 s) (Note 3)	Tsol	260	°C
Isola	ation voltage (AC, 60 s, R.H. ≤ 60 %) (Note 4)	BVs	2500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

- Note 1: 50 % duty cycle, 1 ms pulse width.
- Note 2: Pulse width  $\leq$  1 µs, 300 pps.

Note 3: 2 mm below seating plane.

Note 4: Device considered a two-terminal device: Pins 1, 2, 3 and 4 shorted together and pins 5, 6, 7 and 8 shorted together.

### **Recommended Operating Conditions**

Characteristic	Symbol	Min	Тур.	Max	Unit
Supply voltage	Vcc	0	_	12	V
Forward current (each channel)	lF		16	25	mA
Operating temperature	Topr	-25		85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

### **Electrical Characteristics (Ta = 0°C to 70°C, unless otherwise noted)**

					_		
Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit
Input forward voltage (each channel)		VF	IF = 16 mA, Ta = 25 °C	_	1.65	1.7	V
Temperature coefficent of forward voltage (each channel)		ΔV <sub>F</sub> / ΔTa	IF = 16 mA	$\sim$	-2	_	mV/°C
Input reverse breakdown voltage (each channel)		BV <sub>R</sub>	I <sub>R</sub> = 10 μΑ, Ta = 25 °C	5	)}	_	V
Input capacitance (each channel)		Ст	f = 1 MHz, VF = 0 V		45	_	pF
Logic high output current (each channel)		lou	IF = 0 mA, Vo = V <sub>CC</sub> = 5.5 V Ta = 25 °C		3	500	nA
		ЮН	$I_F = 0 \text{ mA}, V_O = V_{CC} \neq 15 \text{ V}$	_	× C	50	μA
Logic low supply current		ICCL	I <sub>F1</sub> = I <sub>F2</sub> = 16 mA VO1 = VO2 = Open V <sub>CC</sub> = 15 V	$\bigcirc -$	160	> -	μA
Logic high supply current		Іссн	$I_{F1} = I_{F2} = 0 \text{ mA}$ Vo1 = Vo2 = Open V <sub>CC</sub> = 15 V	G	0.05	4	μA
	TLP2530		I <sub>O</sub> / I <sub>F</sub> I <sub>F</sub> = 16 mA, V <sub>O</sub> = 0.4 V V <sub>CC</sub> = 4.5 V, Ta = 25 °C 19 30	30	_	%	
Current transfer ratio	TLP2531	IO / IF		19	30	—	70
(each channel)	TLP2530	IO / IF	IF = 16 mA, V <sub>O</sub> = 0.4 V	5	_	-	%
	TLP2531		V <sub>CC</sub> = 4.5 V	15	_	—	70
Logic low output	TLP2530	$\left(\begin{array}{c} \\ \\ \\ \\ \end{array}\right)$	IF = 16 mA, I <sub>O</sub> = 1.1 mA V <sub>CC</sub> = 4.5 V	_	0.1	0.4	V
voltage (each channel)	TLP2531	Vol	IF = 16 mA, IO = 2.4 mA VCC = 4.5 V	_	0.1	0.4	v
Resistance (input-output)		Rs	Vs = 500 V R.H. ≤ 60 % (Note 1)	5×10 <sup>10</sup>	10 <sup>14</sup>	_	Ω
Capacitance (input-output)		Cs	f = 1 MHz (Note 1)	-	0.6	_	pF
Resistance (input-input)		RŀI	V <sub>I-I</sub> = 500 V (Note 1)	_	10 <sup>11</sup>	—	Ω
Capacitance (input-iutput)		CI-I	f = 1 MHz (Note 1)	_	0.25	_	pF

Note: All typicals at Ta = 25 °C.

Note 1: Device considered a two-terminal device: Pins 1, 2, 3 and 4 shorted together and pins 5, 6, 7 and 8 shorted together.

### Switching Characteristics (unless otherwise specified, Ta = 25°C, Vcc = 5V, IF = 16mA)

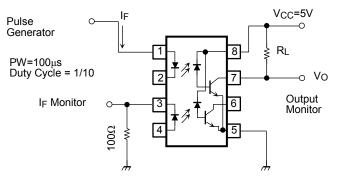
Characteristic		Symbol	Test Cir- cuit	Test Condition	Min	Тур.	Max	Unit
Propagation delay time to logic low	TLP2530	- tрн∟	1	R <sub>L</sub> = 4.1 kΩ	_	0.3	1.5	. µs
at output (each channel)	TLP2531			RL = 1.9 kΩ	$\lambda$	0.2	0.8	
Propagation delay time to logic	TLP2530	tpLH	1	R <sub>L</sub> = 4.1 kΩ	$\mathcal{L}$	0.5	1.5	μs
high at output (each channel)	TLP2531			RL = 1.9 kΩ	()	0.3	0.8	
Common mode transient immunity at logic	TLP2530		2	$V_{CM} = 400 V_{p-p}$ R <sub>L</sub> = 4.1 kΩ, I <sub>F</sub> = 0 mA	_	1500	_	- V / µs
high level output (each channel) (Note 1)	TLP2531	CM <sub>H</sub>	2	V <sub>CM</sub> = 400 V <sub>p-p</sub> R <sub>L</sub> = 1.9 kΩ, I <sub>F</sub> = 0 mA	_	1500	$\geq$	
Common mode transient immunity at logic	TLP2530	СМі	2	$V_{CM} = 400 V_{p-p}$ R <sub>L</sub> = 4.1 kΩ, I <sub>F</sub> = 16 mA		-1500		V / µs
low level output (each channel) (Note 1)	TLP2531		2	$V_{CM} = 400 V_{p-p}$ RL = 1.9 kΩ, IF = 16 mA		-1500	_	ν, μο
Bandwidth (each channel)		BW	3	RL = 100 Ω	A	2	_	MHz

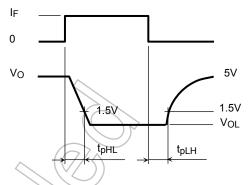
Note 1: Common mode transient immunity in logic high level is the maximum tolerable (positive) dVcm / dt on the leading egde of the common mode pulse, Vcm, to assure that the output will remain in a logic high state (i.e., V<sub>0</sub> > 2.0 V).

Common mode transient immunity in logic low Level is the maximum tolerable (negative) dVcm / dt on the trailing edge of the common mode pulse signal, Vcm, to assure that the output will remain in logic low state (i.e.,  $V_0 < 0.8$  V).

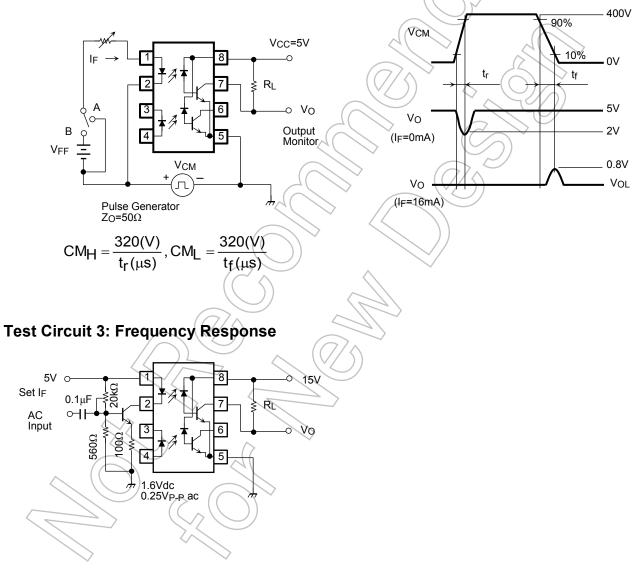
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### Test Circuit 1: Switching Time, tpHL, tpLH

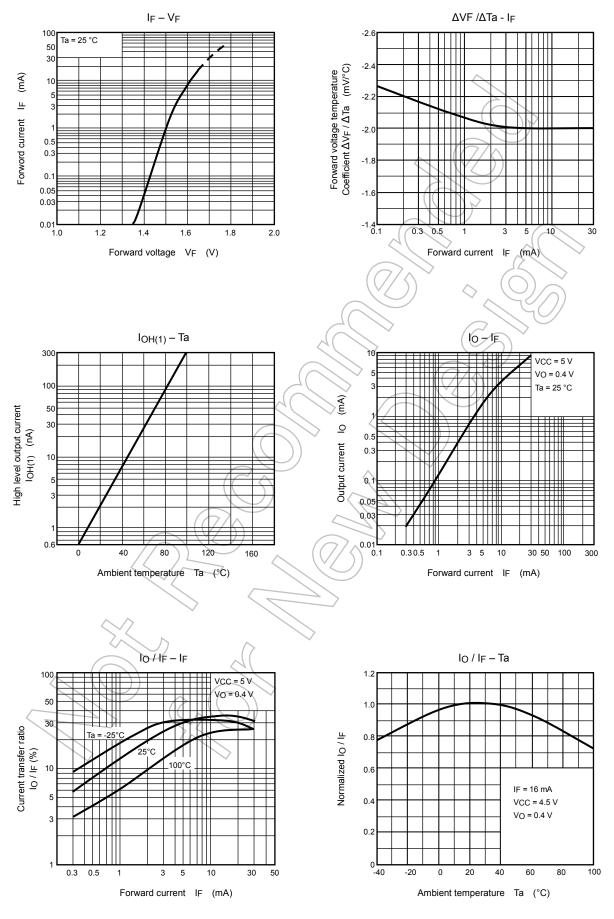


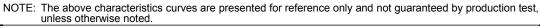


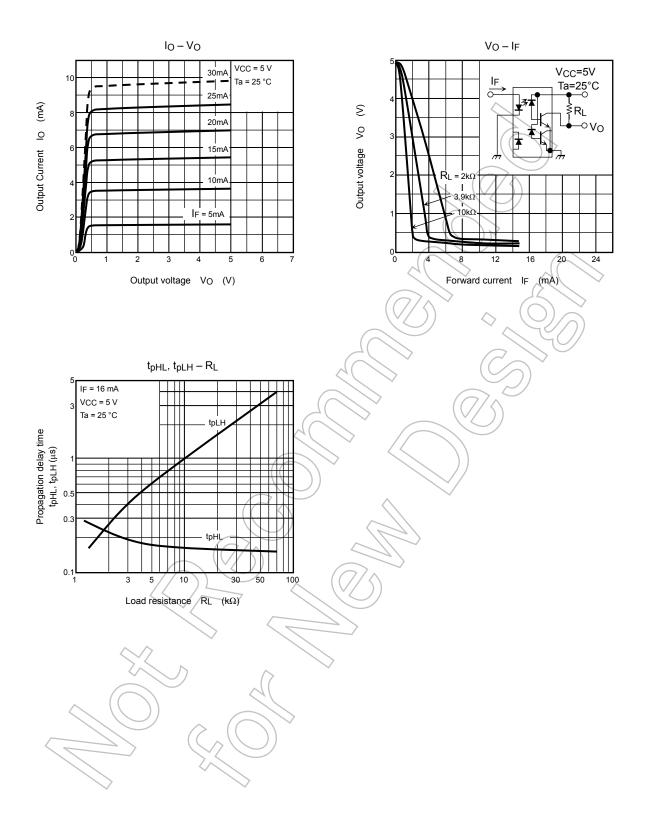
### Test Circuit 2: Common mode transient Immunity and Typical Waveform



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NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

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